Technical data sheet



ENYDYNE® T 67665 A

Product type

Unsaturated polyester resin in styrene, DCPD

Appearance

Light

Main resin characteristics

Preaccelerated, Medium reactivity, Medium viscosity

Main applications

General purpose, Isothermal sandwich panels

Moulding informations

Hand lay up and Spray up

First Emission: 02/11/2016

Version: 02, 18/10/2017

Shelf life and storage

Store in the shade, out of direct sunlight. Keep storage temperature below 25°C. Unseal container just before use. Shelf-life will be reduced reaching higher temperature.

Precaution for handling

Read carefully the Safety Data Sheet

Note

FEATURES OF THE LIQUID RESIN				
_Properties	Test_Method	<i>_Un<u>i</u>t</i>	Typical_values	
Specific weight at 20°C		g/cm³	1,09	
Brookfield viscosity at 23°C, sp 2 rpm 50	MT-CU023V	mPa.s	200 - 300	
Solid content	MT-CU001C	%	65 - 69	
Reactivity	at 23°C + 1,5% MEKP50			
Gel time	MT-CU151R	minutes	37 - 47	
23°C - Peak	MT-CU151R	minutes	65 - 85	
Exothermic peak	MT-CU151R	°C	100 - 120	
Shelf life at 23°C in the dark	MT-CU002S	months	6	

PROPERTIES OF THE CURED UNREINFORCED RESI	<u>N</u>		
Curing cycle	24h at 23°C + 2h at 100°C + 1h at 100°C		
Tensile strength	ISO 527 (2012)	MPa	40
Tensile modulus	ISO 527 (2012)	MPa	3290
Elongation at break	ISO 527 (2012)	%	1.30
Flexural strength	ISO 178 (2011)	MPa	70
Flexural modulus	ISO 178 (2011)	MPa	3560
HDT	ISO 75 -2A (2013)	°C	83

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